FAIRCHILD
SEMICONDUCTOR TM

FDH/FDLL 400

DO-35

LL-34

THE PLACEMENT OF THE EXPANSION GAP HAS NO RELATIONSHIP TO THE LOCATION OF THE CATHODE TERMINAL

COLOR BAND MARKING

DEVICE	1ST BAND	2ND BAND
FDLL400	BROWN	VIOLET

High Voltage General Purpose Diode

Sourced from Process 1J. See MMBD1401-1405 for characteristics.

Absolute Maximum Ratings*

TA = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
W_{IV}	Working Inverse Voltage **FDH/FDLL400**	150	V
I_O	Average Rectified Current	200	mA
I_F	DC Forward Current	500	mA
i_f	Recurrent Peak Forward Current	600	mA
$i_{f(surge)}$	Peak Forward Surge Current Pulse width = 1.0 second Pulse width = 1.0 microsecond	 1.0 4.0	 A A
T_{stg}	Storage Temperature Range	-65 to +200	°C
T_J	Operating Junction Temperature	175	°C

*These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

NOTES:
1) These ratings are based on a maximum junction temperature of 200 degrees C.
2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

Thermal Characteristics

TA = 25°C unless otherwise noted

Symbol	Characteristic	Max	Units
		FDH/FDLL 400	
P_D	Total Device Dissipation Derate above 25°C	500 3.33	mW mW/°C
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	300	°C/W

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High Voltage General Purpose Diode
(continued)

Electrical Characteristics
TA = 25°C unless otherwise noted

Symbol	Parameter		Test Conditions	Min	Max	Units
B_V	Breakdown Voltage	**FDH/FDLL400**	I_R = 100 μA	200		V
I_R	Reverse Current	**FDH/FDLL400**	V_R = 150 V V_R = 150 V, T_A = 150°C		100 100	nA μA
V_F	Forward Voltage	**FDH/FDLL400**	I_F = 200 mA I_F = 300 mA		1.0 1.1	V V
C_O	Diode Capacitance	**FDH/FDLL400**	V_R = 0, f = 1.0 MHz		2.0	pF
T_{RR}	Reverse Recovery Time	**FDH/FDLL400**	I_F = I_R = 30 mA, I_{rr} = 3.0 mA, R_L = 100 Ω		50	nS

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

PRODUCT STATUS DEFINITIONS

Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
Obsolete	Not In Production	This datasheet contains specifications on a product that has been discontinued by Fairchild semiconductor. The datasheet is printed for reference information only.

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